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PATENT APPLICATION

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J. Osher
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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Bogursky et al.

Application No.: 10/084,125

Filed: 2/28/02

Art Unit: 3729

Examiner:

For: Discrete Solder Ball Contact, etc.
Commissioner Of Patents And Trademarks
Washington, D.C. 20231
Sir:

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AUG - 6 2002
TECHNOLOGY CENTER R370

LETTER TO CHIEF DRAFTSPERSON

Subject to the Examiner's approval, enclosed herewith are 5 sheets of new formal
drawings, which if approved please substitute for those presently in the file.

Respectfully submitted,
J. Bogursky et al.

7/29/02

J. Osher, attorney
Reg. No. 17317